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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/588,959	08/10/2006	Satoshi Eguchi	1374.46346X00	4026
20457 7590 08/19/2008 ANTONELLI, TERRY, STOUT & KRAUS, LLP 1300 NORTH SEVENTEENTH STREET			EXAMINER	
			SLUTSKER, JULIA	
SUITE 1800 ARLINGTON, VA 22209-3873			ART UNIT	PAPER NUMBER
			2891	
			MAIL DATE	DELIVERY MODE
			08/19/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)			
	10/588,959	EGUCHI ET AL.			
Office Action Summary	Examiner	Art Unit			
	JULIA SLUTSKER	2891			
The MAILING DATE of this communication app	ears on the cover sheet with the c	orrespondence address			
Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE <u>3</u> MONTH(S) OR THIRTY (30) DAYS,					
WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period was pailing to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	lely filed the mailing date of this communication. (35 U.S.C. § 133).			
Status					
1)⊠ Responsive to communication(s) filed on <u>27 Ju</u>	ne 2008				
	action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	33 O.G. 213.			
Disposition of Claims					
4)⊠ Claim(s) <u>1 and 3-20</u> is/are pending in the applie	cation.				
4a) Of the above claim(s) <u>6, 13-16</u> is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6) Claim(s) <u>1,3-5,7-12 and 17-20</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or	election requirement.				
Application Papers					
9) The specification is objected to by the Examine	r.				
10)⊠ The drawing(s) filed on <u>10 August 2006</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a)⊠ All b)□ Some * c)□ None of:					
1. Certified copies of the priority documents have been received.					
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau (PCT Rule 17.2(a)).					
* See the attached detailed Office action for a list of the certified copies not received.					
Attacharanta					
Attachment(s) 1) Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)			
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date					
3) ☑ Information Disclosure Statement(s) (PTO/SB/08) 5) ☐ Notice of Informal Patent Application Paper No(s)/Mail Date 08/10/2006. 6) ☐ Other:					
1 apos 110 (0) mini Bato 00/10/2000.					

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DETAILED ACTION

Election/Restrictions

- 1. Applicant's election without traverse of Group I, Species I in the reply filed on June 27, 2008 is acknowledged.
- 2. Claims 1, 3-5, 7-12 and 17-20 reads on the elected Group I, Species I. It is noted that claim 2 has been canceled according to the preliminary amendment filed on August 10, 2006.
- 3. Claims 6, and 13-15 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected Group II, Species II, there being no allowable generic or linking claim. Election was made **without** traverse in the reply filed on June 27, 2008.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States
- 5. Claims 1, 3-5, 7, and 17-20 are rejected under 35 U.S.C. 102(b) as being anticipated by Sukegawa'370.

Regarding claim 1, Sukegawa discloses a manufacturing method of a semiconductor device comprising the steps of: (a) preparing a first raw material gas which contains a silane-based compound gas containing carbon atoms with first concentration of 0.3.% or more in a first hydrogen gas (Fig.10, numeral 16); (b)

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producing a first diluted raw material gas containing the silane-based compound gas with the second concentration lower than the first concentration by diluting the first raw material gas with a second hydrogen gas (page 6, [0888]); (c) supplying after the step (b) a first portion of the first diluted raw material gas into the inside of a reaction chamber in which a wafer to be processed is accommodated (page 6, [0888]) and (d) forming a SiGe:C epitaxial layer or SiGe-based epitaxial layer on the a first main surface of the wafer to be processed using the first portion of the supplied first diluted raw material gas (page 6, [0090]), wherein a remaining second portion of the first diluted raw material gas is not supplied on the reaction chamber (note: some portion of the mixed gas are always remains in the gas supply pipe (120) when SiGe:C layer is growing).

Regarding claim 3, Sukegawa discloses that the first hydrogen gas and the second hydrogen gas have the substantially same concentration composition (Fig.10, numeral 30).

Regarding claim 4, Sukegawa discloses that the purity of the second hydrogen gas is 99.999% or more (page 3, [0049]).

Regarding claim 5, Sukegawa discloses that the reaction chamber is an epitaxial layer forming reaction chamber of a single wafer epitaxial device (page 3, [0045], [0046]).

Regarding claim 7, Sukegawa discloses that epitaxial layer constitutes a portion of a base region of a HBT (page 2, [0034], [0037]).

Regarding claims 17-20, Sukegawa discloses that the first concentration is more than 5% (column 6, [0888]).

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Claim Rejections - 35 USC § 103

6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

7. Claim 8 is rejected under 35 U.S.C. 103(a) as being unpatentable over Sukegawa as applied to claim 1 above, and further in view of Takahashi'211.

Regarding claim 8, Sukegawa appears not to explicitly disclose that the epitaxial layer is a channel region of a strain SiGe-based MISFET. Takahashi however discloses that SiGe:C epitaxial layer is a channel region of a strain SiGe-based MISFET (column 5, lines 24-40; column 16, lines 55-61).

It would have been therefore obvious to one of ordinary skill in the art at time the invention was made to use SiGe:C epitaxial layer as a channel region of a strain SiGe-based MISFET for the purpose of obtaining MISFET operating at high speeds (Sukegawa, column 16, lines 62-67).

8. Claims 9-12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Sukegawa.

Regarding claims 9-12, Sukegawa appears not to explicitly disclose the degree of dilution of first diluted raw material gas is set to value which falls within a range of 6 to 15.

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Sukegawa however discloses that the first raw material is diluted with hydrogen gas such that a higher flow rate is gained under the condition that silicon-germanium layer is doped with a predetermined concentration of carbon (page 6, [0888])

It would have been therefore obvious to one of ordinary skill in the art at time the invention was made to dilute the first raw material to a value which is set within claimed range for the purpose of gaining the higher flow rate of carbon source gas and to efficiently inhibit boron diffusion (page 6, [0088]).

Conclusion

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to JULIA SLUTSKER whose telephone number is (571)270-3849. The examiner can normally be reached on Monday-Friday, 8 a.m.-5 p.m. EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, William Baumeister can be reached on (571)-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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10. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information

system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

JS August 13, 2006

/Douglas M Menz/ Primary Examiner, Art Unit 2891 8/17/08